

PRODUCT SPECIFICATION

Part Number PDM88150-A Series

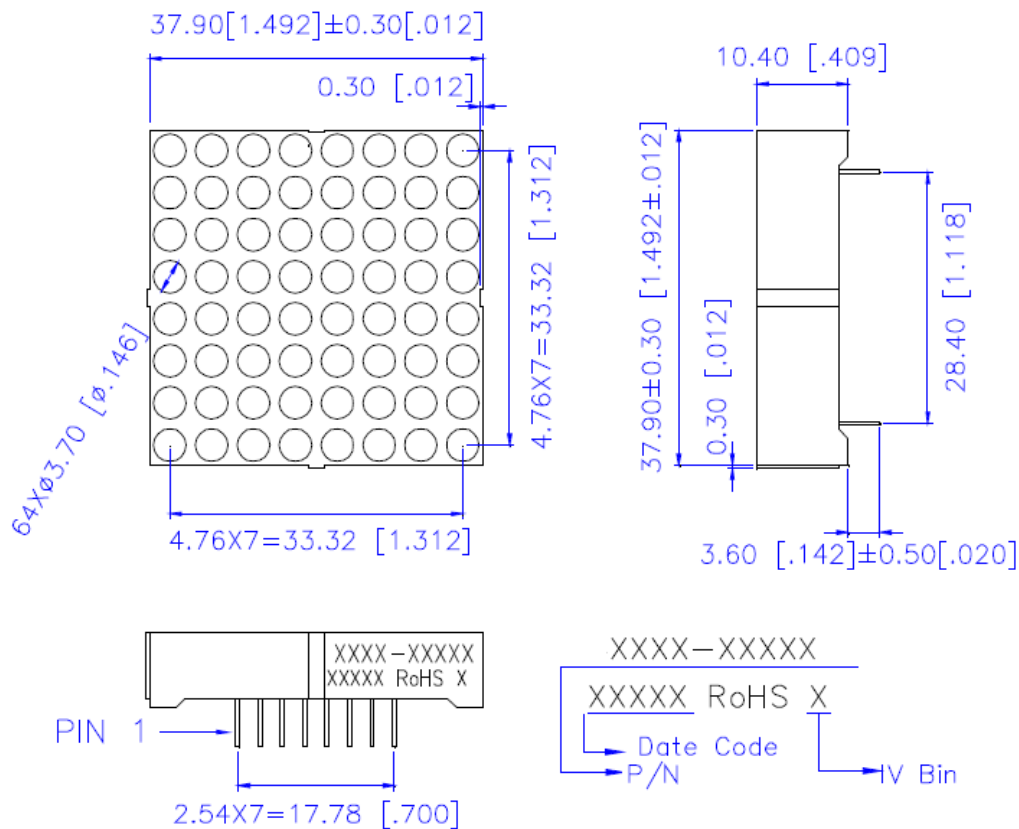
Details

- 1.5" (37.02mm) Dot Matrix Display
- 8x8 Array
- Available in Common Anode or Cathode
- Emitting Color: Pure Green, Yellow Green, Yellow, Amber, Orange-Red, Red or Deep Red

Features

- Low power consumption
- RoHS Compliant
- Gray or Black Face, White Segment
- Easy mounting on PCB or socket

Mechanical Dimensions



Notes:

1. Dimensions in millimeters [inch], and tolerance is $\pm 0.25 [.010]$ and angle is $\pm 1^\circ$ unless otherwise noted.
2. Bending $\leq$ Length*1%
3. All pins are $\phi 0.60 [0.020] \pm 0.1 [.004]$
4. Specification subject to change without notice.





Device Selection Guide

Model Number	Chip		Description
	Material	Emitting Color	
PDM88150x-G05-A	InGaN	True Green	Common Cathode x=C / Common Anode x=A
PDM88150x-G17-A	AlInGaP	Yellow Green	
PDM88150x-Y04-A		Yellow	
PDM88150x-A11-A		Amber	
PDM88150x-R02-A		Orange-Red	
PDM88150x-R11-A		Red	
PDM88150x-R21-A		Deep Red	

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating		Unit
		G17/Y04/A11/R02/R11/R21	G05	
Power Dissipation per Dice	P _{AD}	70	114	mW
Derating Liner from 25°C per Dice	--	0.33	0.4	mA/°C
Continuous Forward Current Per Dice	I _{AF}	25	30	mA
Peak Current Per Dice (duty cycle 1/10, 1KHz)	I _{PF}	90	100	mA
Reverse Voltage Per Dice	V _R	5	5	V
Electrostatic Discharge (HBM)	ESD	/	1000	V
Operating Temperature	T _{opr}	-35~+85		°C
Storage Temperature	T _{stg}	-35~+85		°C

Solder Conditions: 1/16 inch below seating plane for 3 -5 seconds at 260°C.

Electrical and Optical Characteristics at Ta=25°C

Parameter	Symbol	Chip	Min.	Typ.	Max.	Unit	Condition
Forward Voltage Per Segment	VF	G05	--	3.2	3.8	V	IF=20mA
		G17/Y04/A11/R02/R11/R21	--	2	2.8		
Luminous Intensity Per Segment	Iv	G05	--	350	--	mcd	IF=10mA
		G17	--	21	--		
		Y04	--	63	--		
		A11	--	82	--		
		R02	--	50	--		
		R11	--	44	--		
		R21	--	23	--		
Peak Emission Wavelength / Dominant Wavelength	$\lambda P/\lambda d$	G05	--	*525	--	nm	IF=20mA
		G17	--	572/570	--		
		Y04	--	592/590	--		
		A11	--	612/605	--		
		R02	--	632/625	--		
		R11	--	644/630	--		
		R21	--	660/645	--		
Reverse Current	IR		--	--	100	μA	VR=5V
Luminous Intensity Matching Ratio	Iv-m		--	--	2:1	--	IF=10mA

Typical Electrical/Optical Characteristic Curves

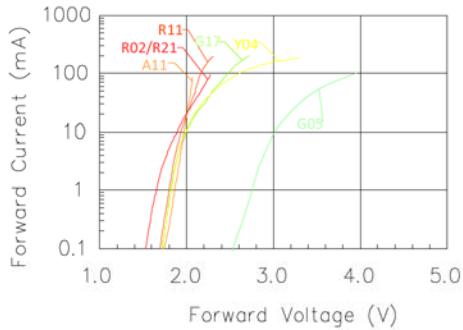


Fig 1. Forward Current vs. Forward Voltage

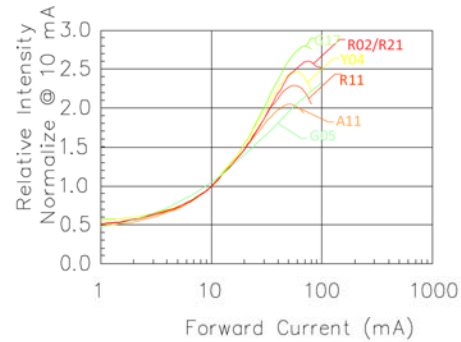


Fig 2. Relative Intensity vs. Forward Current

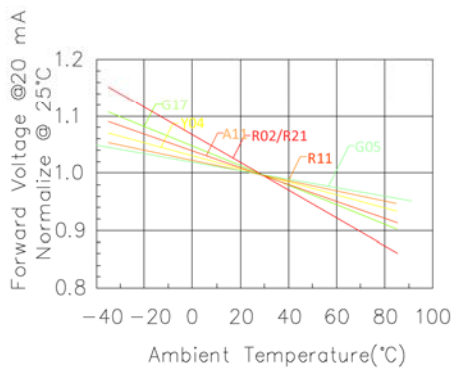


Fig 3. Forward Voltage vs. Temperature

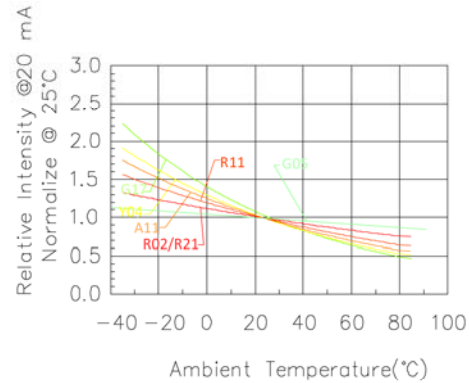


Fig 4. Relative Intensity vs. Temperature

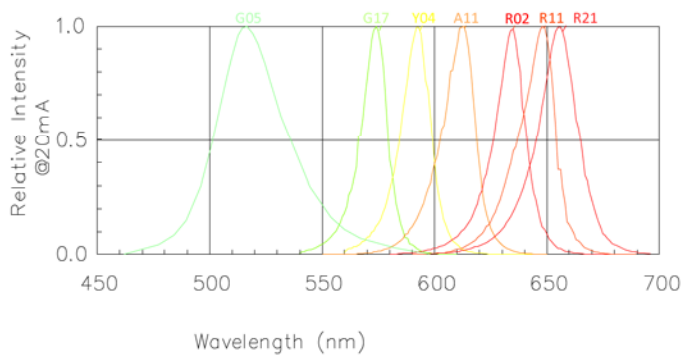


Fig 5. Relative Intensity vs. Wavelength

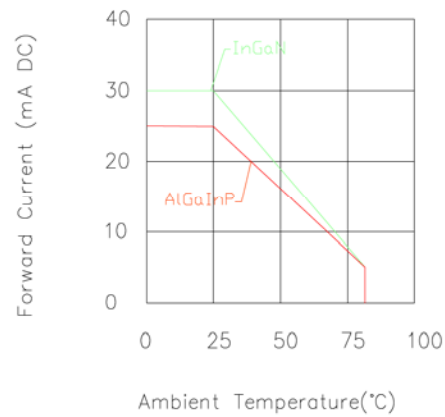


Fig 3. Forward Current vs. Ambient Temperature

Luminous General Iv Bin Grade (IF = 10mA)
Color Rank Limits (IF=20mA)

Remark: Unit=mcd

*Tolerance: ±20%

●Pure Green(G05)

Y	1	2	3	4
202.450	263.185	342.142	444.786	578.222
I	I	I	I	I
263.184	342.141	444.785	578.221	751.689

Remark: Unit=nm

*Tolerance: ±1

1	2	3	4	5
515.0	518.0	520.0	522.0	524.0
I	I	I	I	I
518.0	520.0	522.0	524.0	527.0

●Yellow Green(G17)

M	N	P	Q	R
11.293	14.682	19.088	24.815	32.261
I	I	I	I	I
14.681	19.087	24.814	32.260	41.939

0	1	2	3	4
567.5	569.5	570.5	571.5	573.0
I	I	I	I	I
569.4	570.4	571.4	572.9	575.0

●Yellow (Y04)

R	S	T	U	V
32.261	41.940	54.523	70.881	92.146
I	I	I	I	I
41.939	54.522	70.880	92.145	119.790

1	2	3	4	5
583.0	585.0	587.0	589.0	591.0
I	I	I	I	I
585.0	587.0	589.0	591.0	593.0

●Amber (A11)

S	T	U	V	W
41.940	54.523	70.881	92.146	119.791
I	I	I	I	I
54.522	70.880	92.145	119.790	155.729

●Orange (R02)

R	S	T	U	V
32.261	41.940	54.523	70.881	92.146
I	I	I	I	I
41.939	54.522	70.880	92.145	119.790

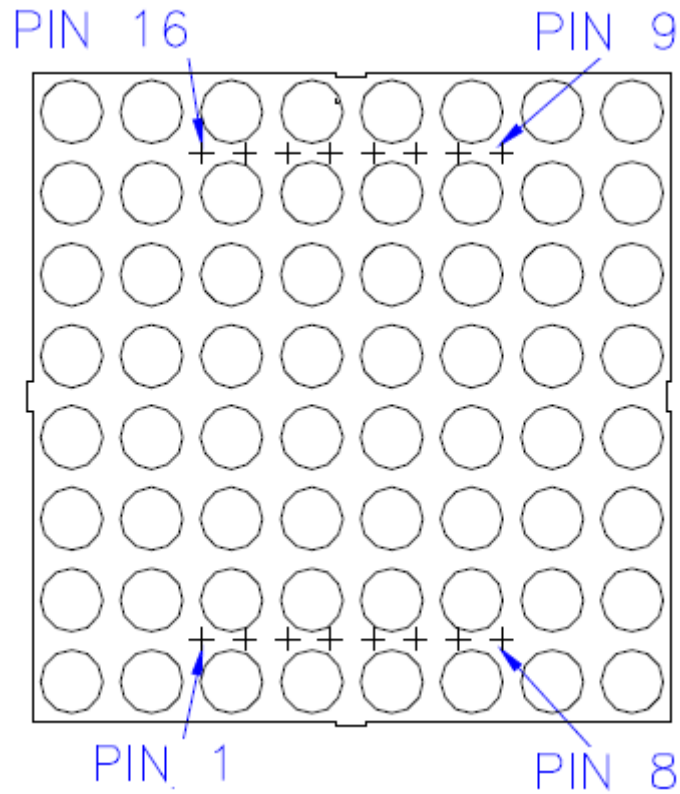
●Red (R11)

Q	R	S	T	U
24.815	32.261	41.940	54.523	70.881
I	I	I	I	I
32.260	41.939	54.522	70.880	92.145

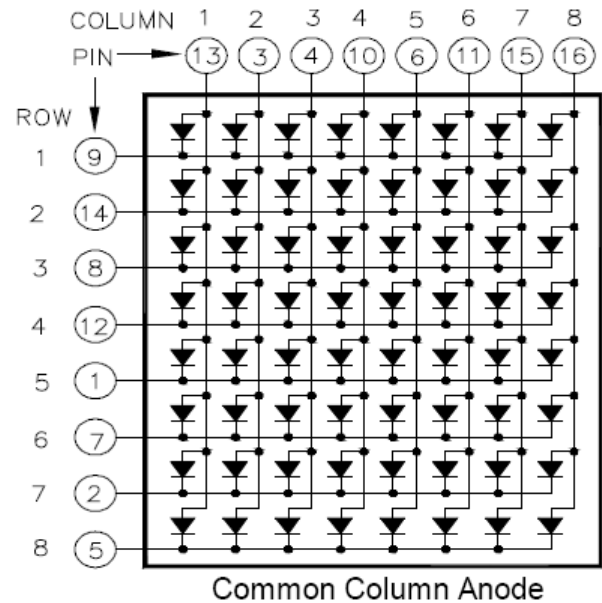
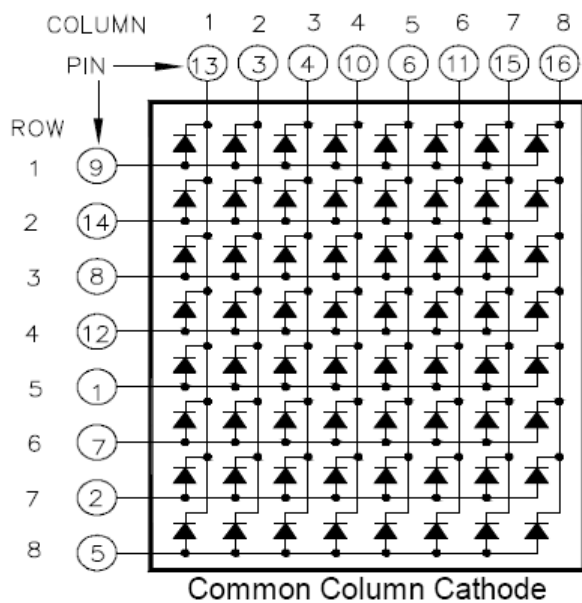
●Deep Red(R21)

N	P	Q	R	S
14.682	19.088	24.815	32.261	41.940
I	I	I	I	I
19.087	24.814	32.260	41.939	54.522

All Light-On Segments Feature & Pad Position



Internal Circuit Diagram

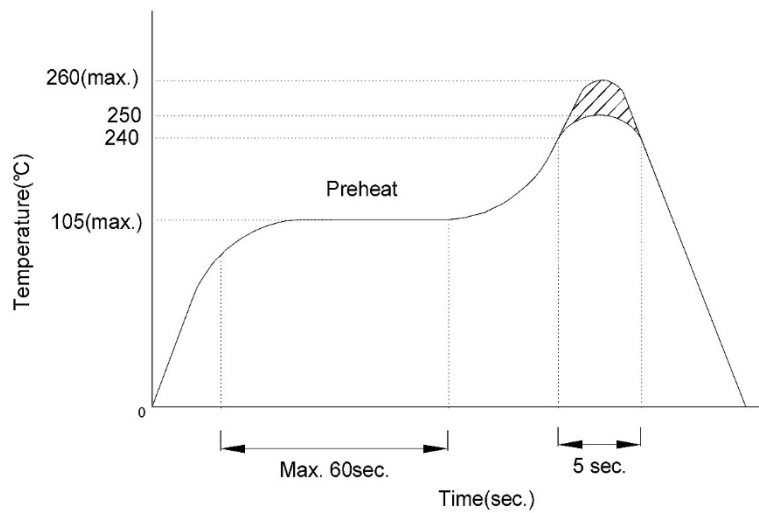


Precautions for Use

1. Recommended soldering conditions

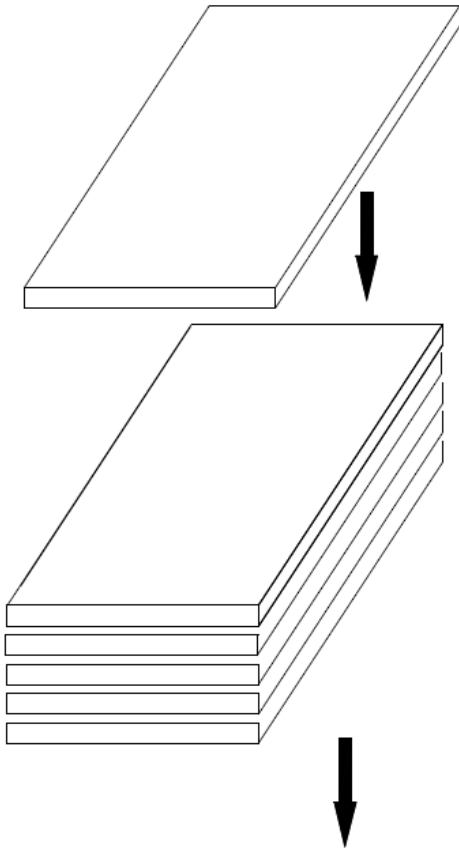
1.1. Wave soldering

Basic SPEC is $\leq 5\text{sec}$. When 260°C . If temperature is higher, time should be shorter ($+10^{\circ}\text{C} \rightarrow -1\text{sec.}$).



1.2. Soldering Iron:

Power dissipation of iron should be smaller than 15W and temp should be controllable. Soldering temperature should be under 260°C , time $\leq 3\text{sec}$.

Packing Dimensions

24 Pcs Per PE.foam
PE.foam Size:
L295xW195xH15mm

8 PE.foam Per Box
Q'TY: 192 PCS
Box Size:
L300*W205*H240mm